

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



**OPC unified architecture –  
Part 100: Device Interface**

**IEC STANDARD PREVIEW**  
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**Architecture unifiée OPC –  
Partie 100: Interface d'appareils**

[IEC 62541-100:2015](#)

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**OPC UNIFIED ARCHITECTURE –**

**Part 100: Device Interface**

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CDV	Report on voting
65E/372/CDV	65E/412/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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# OPC UNIFIED ARCHITECTURE –

## Part 100: Device Interface

### 1 Scope

This part of IEC 62541 is an extension of the overall OPC Unified Architecture standard series and defines the information model associated with *Devices*. This part of IEC 62541 describes three models which build upon each other as follows:

- the (base) Device Model is intended to provide a unified view of devices irrespective of the underlying device protocols;
- the Device Communication Model adds Network and Connection information elements so that communication topologies can be created;
- the Device Integration Host Model finally adds additional elements and rules required for host systems to manage integration for a complete system. It allows reflecting the topology of the automation system with the devices as well as the connecting communication networks.

### 2 Reference documents

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

<https://standards.iteh.ai/catalog/standards/sist/46a64832-c3c4-414c-a48f-ae0c63dce7d5/iec-62541-100-2015>  
IEC TR 62541-1, *OPC Unified Architecture – Part 1: Overview and Concepts*

IEC 62541-3, *OPC Unified Architecture – Part 3: Address Space Model*

IEC 62541-4 *OPC Unified Architecture – Part 4: Services*

IEC 62541-5, *OPC Unified Architecture – Part 5: Information Model*

IEC 62541-6, *OPC Unified Architecture – Part 6: Mappings*

IEC 62541-7, *OPC Unified Architecture – Part 7: Profiles*

IEC 62541-8, *OPC Unified Architecture – Part 8: Data Access*

NAMUR Recommendation NE107: *Self-monitoring and diagnosis of field devices*

### 3 Terms, definitions, abbreviations and used data types

#### 3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC TR 62541-1, IEC 62541-3, and IEC 62541-8 as well as the following apply.

##### 3.1.1

##### **block**

functional *Parameter* grouping entity

Note 1 to entry: It could map to a function block (see IEC 62769 (all parts), *Field Device Integration (FDI)*

) or to the resource parameters of the device itself.

### 3.1.2

#### **blockMode**

mode of operation (target mode, permitted modes, actual mode, and normal mode) for a *Block*

Note 1 to entry: Further details about *Block* modes are defined by standard organisations.

### 3.1.3

#### **Communication Profile**

fixed set of mapping rules to allow unambiguous interoperability between *Devices* or *Applications*, respectively

Note 1 to entry: Examples of such profiles are the “Wireless communication network and communication profiles for WirelessHART” in IEC 62591 and the Protocol Mappings for OPC UA in IEC 62541-6.

### 3.1.4

#### **Connection Point**

logical representation of the interface between a *Device* and a *Network*

### 3.1.5

#### **device**

independent physical entity capable of performing one or more specified functions in a particular context and delimited by its interfaces

Note 1 to entry: See IEC 61499-1.

Note 2 to entry: *Devices* provide sensing, actuating, communication, and/or control functionality. Examples include transmitters, valve controllers, drives, motor controllers, PLCs, and communication gateways.

### 3.1.6

#### **Device Integration Host**

*Server* that manages integration of multiple *Devices* in an automation system

### 3.1.7

#### **Device Topology**

arrangement of *Networks* and *Devices* that constitute a communication topology

### 3.1.8

#### **fieldbus**

communication system based on serial data transfer and used in industrial automation or process control applications

Note 1 to entry: See IEC 61784.

Note 2 to entry: Designates the communication bus used by a *Device*.

### 3.1.9

#### **parameter**

variable of the *Device* that can be used for configuration, monitoring or control purposes

Note 1 to entry: In the information model it is synonymous to an OPC UA *DataVariable*.

### 3.1.10

#### **network**

means used to communicate with one specific protocol

**3.2 Abbreviations**

- ADI Analyser Device Integration
- CP Communication Processor (hardware module)
- CPU Central Processing Unit (of a *Device*)
- DA Data Access
- DI Device Integration (the short name for this standard)
- UA Unified Architecture
- UML Unified Modelling Language
- XML Extensible Mark-up Language

**3.3 Used data types**

Table 1 describes the *DataTypes* that are used throughout this document.

**Table 1 – DataTypes defined in IEC 62541-3**

Parameter Type
Argument
Boolean
Duration
LocalizedText
String
Int32

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**4 Fundamentals**

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**4.1 OPC UA**

The main use case for OPC standards is the online data exchange between devices and HMI or SCADA systems using Data Access functionality. In this use case the device data is provided by an OPC *Server* and is consumed by an OPC *Client* integrated into the HMI or SCADA system. OPC DA provides functionality to browse through hierarchical namespaces containing data items and to read, write and to monitor these items for data changes. The classic OPC standards are based on Microsoft COM/DCOM technology for the communication between software components from different vendors. Therefore classic OPC *Server* and *Clients* are restricted to Windows PC based automation systems.

OPC UA incorporates all features of classic OPC standards like OPC DA, A&E and HDA but defines platform independent communication mechanisms and generic, extensible and object-oriented modelling capabilities for the information a system wants to expose.

The OPC UA network communication part defines different mechanisms optimized for different use cases. The current version of OPC UA is defining an optimized binary protocol for high performance intranet communication as well as Web Services. It allows adding new protocols in the future. Features like security, access control and reliability are directly built into the transport mechanisms. Based on the platform independence of the protocols, OPC UA *Servers* and *Clients* can be directly integrated into devices and controllers.

The OPC UA *Information Model* provides a standard way for *Servers* to expose *Objects* to *Clients*. *Objects* in OPC UA terms are composed of other *Objects*, *Variables* and *Methods*. OPC UA also allows relationships to other *Objects* to be expressed.

The set of *Objects* and related information that an OPC UA *Server* makes available to *Clients* is referred to as its *AddressSpace*. The elements of the OPC UA *Object Model* are represented in the *AddressSpace* as a set of *Nodes* described by *Attributes* and

interconnected by *References*. OPC UA defines eight classes of *Nodes* to represent *AddressSpace* components. The classes are *Object*, *Variable*, *Method*, *ObjectType*, *VariableType*, *DataType*, *ReferenceType* and *View*. Each *NodeClass* has a defined set of *Attributes*.

This standard makes use of almost all OPC UA *NodeClasses*.

*Objects* are used to represent real-world entities such as *Devices* and (communication) Networks as well as software entities such as *Blocks*. An *Object* is associated to a corresponding *ObjectType* that provides definitions for that *Object*.

*Variables* are used to represent values. Two categories of *Variables* are defined, *Properties* and *DataVariables*.

*Properties* are Server-defined characteristics of *Objects*, *DataVariables* and other *Nodes*. *Properties* are not allowed to have *Properties* defined for them. Examples for *Properties* of *Objects* are the device serial number and the block tag.

*DataVariables* represent the contents of an *Object*. *DataVariables* may have component *DataVariables*. This is typically used by *Servers* to expose individual elements of arrays and structures. This standard uses *DataVariables* to represent the *Parameters* of both *Blocks* and *Devices*.

## 4.2 Conventions used in this document

### 4.2.1 Conventions for Node descriptions

*Node* definitions are specified using tables (see Table 2).

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**Table 2 – Type definition table**

Attribute	Value				
Attribute name	Attribute value. If it is an optional Attribute that is not set "--" will be used.				
References	NodeClass	BrowseName	DataType	TypeDefinition	ModellingRule
<i>ReferenceType</i> name	<i>NodeClass</i> of the <i>TargetNode</i> .	<i>BrowseName</i> of the target <i>Node</i> . If the <i>Reference</i> is to be instantiated by the server, then the value of the target <i>Node</i> 's <i>BrowseName</i> is "--".	<i>Attributes</i> of the referenced <i>Node</i> , only applicable for <i>Variables</i> and <i>Objects</i> .		Referenced <i>ModellingRule</i> of the referenced <i>Object</i> .
NOTE Notes referencing footnotes of the table content.					

*Attributes* are defined by providing the *Attribute* name and a value, or a description of the value.

*References* are defined by providing the *ReferenceType* name, the *BrowseName* of the *TargetNode* and its *NodeClass*.

- If the *TargetNode* is a component of the *Node* being defined in the table the *Attributes* of the composed *Node* are defined in the same row of the table.
- The *DataType* is only specified for *Variables*; “[<number>]” indicates a single-dimensional array, for multi-dimensional arrays the expression is repeated for each dimension (e.g. [2][3] for a two-dimensional array). For all arrays the *ArrayDimensions* is set as identified by <number> values. If no <number> is set, the corresponding dimension is set to 0, indicating an unknown size. If no number is provided at all the *ArrayDimensions* can be omitted. If no brackets are provided, it identifies a scalar *DataType* and the *ValueRank* is set to the corresponding value (see IEC 62541-3). In

addition, *ArrayDimensions* is set to null or is omitted. If it can be *Any* or *ScalarOrOneDimension*, the value is put into “{<value>}”, so either “{*Any*}” or “{*ScalarOrOneDimension*}”. The *ValueRank* is set to the corresponding value (see IEC 62541-3) and the *ArrayDimensions* is set to null or is omitted. In Table 3 examples are given.

**Table 3 – Examples of DataTypes**

Notation	Data-Type	Value-Rank	ArrayDimensions	Description
Int32	Int32	-1	omitted or NULL	A scalar Int32
Int32[]	Int32	1	omitted or {0}	Single-dimensional array of Int32 with an unknown size
Int32[][]	Int32	2	omitted or {0,0}	Two-dimensional array of Int32 with unknown sizes for both dimensions
Int32[3][]	Int32	2	{3,0}	Two-dimensional array of Int32 with a size of 3 for the first dimension and an unknown size for the second dimension
Int32[5][3]	Int32	2	{5,3}	Two-dimensional array of Int32 with a size of 5 for the first dimension and a size of 3 for the second dimension
Int32{Any}	Int32	-2	omitted or NULL	An Int32 where it is unknown if it is scalar or array with any number of dimensions
Int32{ScalarOrOneDimension}	Int32	-3	omitted or NULL	An Int32 where it is either a single-dimensional array or a scalar

- The *TypeDefinition* is specified for *Objects* and *Variables*.
- The *TypeDefinition* column specifies a *NodeId* of a *TypeDefinitionNode*, i.e. the specified *Node* points with a *HasTypeDefinition Reference* to the corresponding *TypeDefinitionNode*. The symbolic name of the *NodeId* is used in the table.
- The *ModellingRule* of the referenced component is provided by specifying the symbolic name of the rule in the *ModellingRule* column. In the *AddressSpace*, the *Node* shall use a *HasModellingRule Reference* to point to the corresponding *ModellingRule Object*.

If the *NodeId* of a *DataType* is provided, the symbolic name of the *Node* representing the *DataType* shall be used.

If no components are provided, the *DataType*, *TypeDefinition* and *ModellingRule* columns may be omitted and only a *Comment* column is introduced to point to the *Node* definition.

Components of *Nodes* can be complex, i.e. contain components by themselves. The *TypeDefinition*, *NodeClass*, *DataType* and *ModellingRule* can be derived from the type definitions, and the symbolic name can be created as defined in 4.2.2.1. Therefore those containing components are not explicitly specified; they are implicitly specified by the type definitions.

## 4.2.2 NodeIds and BrowseNames

### 4.2.2.1 NodeIds

The *NodeIds* of all *Nodes* described in this document are only symbolic names. Annex A defines the actual *NodeIds*.

The symbolic name of each *Node* defined in this document is its *BrowseName*, or, when it is part of another *Node*, the *BrowseName* of the other *Node*, a “.”, and the *BrowseName* of itself. In this case “part of” means that the whole has a *HasProperty* or *HasComponent Reference* to its part. Since all *Nodes* not being part of another *Node* have a unique name in this document, the symbolic name is unique.

The namespace for this standard is defined in Annex A. The *NamespaceIndex* for all *NodeIds* and *BrowseNames* defined in this standard is server specific and depends on the position of the namespace URI in the server namespace table.

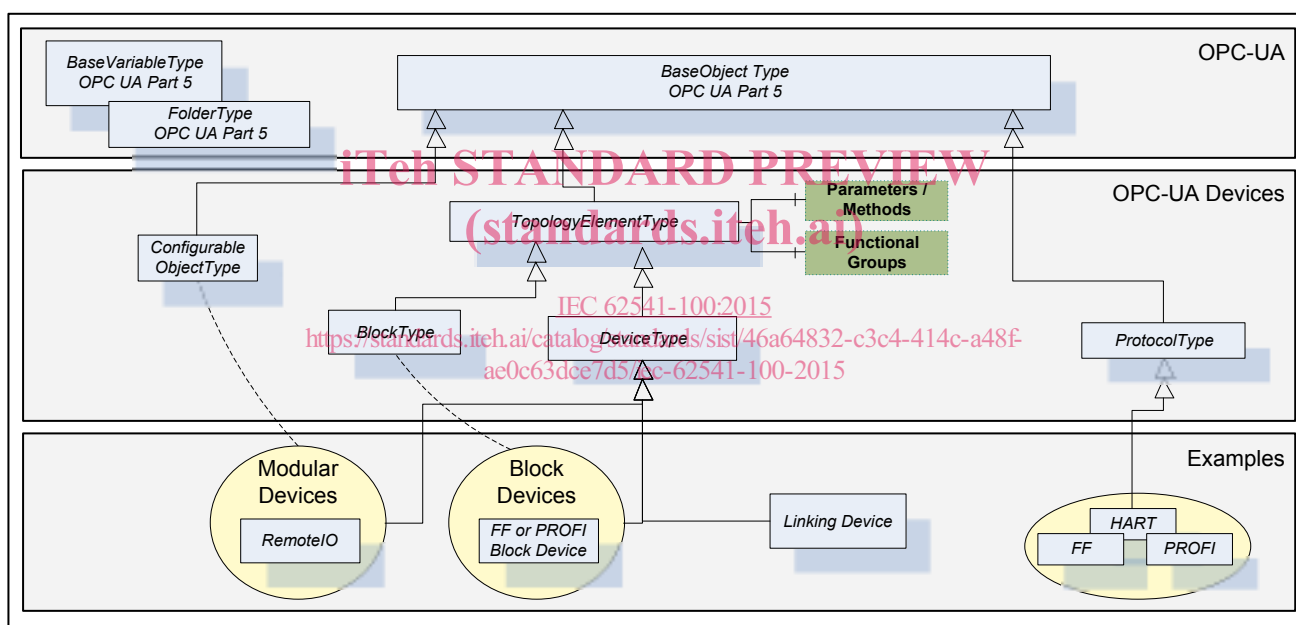
#### 4.2.2.2 BrowseNames

The text part of the *BrowseNames* for all *Nodes* defined in this standard is specified in the tables defining the *Nodes*. The *NamespaceIndex* for all *BrowseNames* defined in this standard is server specific and depends on the position of the namespace URI in the server namespace table.

## 5 Device model

### 5.1 General

Figure 1 depicts the main *ObjectTypes* of the base *Device* model and their relationship. The drawing is not intended to be complete. For the sake of simplicity only a few components and relations were captured so as to give a rough idea of the overall structure.



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**Figure 1 – Device model overview**

The boxes in this drawing show the *ObjectTypes* used in this standard as well as some elements from other standards that help understand some modelling decisions. The upper grey box shows the OPC UA core *ObjectTypes* from which the *TopologyElement Type* and *ProtocolType* are derived. The grey box in the second level shows the main *ObjectTypes* that this standard introduces. The components of those *ObjectTypes* are illustrated only in an abstract way in this overall picture.

The grey box in the third level shows real-world examples as they will be used in products and plants. In general, such subtypes are defined by other organizations.

The *TopologyElement Type* is the base *Object Type* for elements in a device topology. It introduces *Parameters* and *Methods*. This standard also defines a functional grouping concept to provide alternative viewpoints.